These assemblies are ESD sensitive. ESD precautions shall be observed.
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
Place SH-1 on J1 and SH-J2 on J3 (pins 1-2) and SH-J3 to SH-J4 on J7, SH-J3 (pins 1-2)
Component BL1 must be assembled to U3 before U3 is attached to the board.
Remove protective coverings from BL1 and U3
Slide pins of U3 into holes of BL1. BL1 must lie flat on the back of U3
Solder U3 - BL1 assembly to the board.
Solder Pins 1, 2, 3, 10, 19, and 20 of U3 to BL1 from the top to ensure electrical continuity.

Components marked 'DNP' should not be populated.
Assembly Variant: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-01364</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td>PLOT NAME = Top Assembly Drawing</td>
<td>GENERATED : 11/11/2016 1:35:24 PM</td>
<td>TEXAS INSTRUMENTS</td>
<td></td>
</tr>
</tbody>
</table>
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE

BOARD #: TIDA-01364
REV: A
SUN REV: Not In VersionControl

PLOT NAME = Bottom Assembly Drawing
GENERATED: 11/11/2016 1:35:26 PM
TEXAS INSTRUMENTS
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